

High IP3 Frequency Mixer

HJK-1651H+

Level17 (LO Power +17dBm) 1430 to 1650 MHz



CASE STYLE: TTT881

Maximum Ratings

| | |
|-----------------------|----------------|
| Operating Temperature | -40°C to 85°C |
| Storage Temperature | -55°C to 100°C |
| LO Power | +20 dBm |
| RF Power | +20 dBm |

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

| | |
|--------|-------|
| LO | 2 |
| RF | 1 |
| IF | 3 |
| GROUND | 4,5,6 |

Features

- very high IP3, 32 dBm typ.
- excellent L-R isolation, 45 dB typ.; L-I isolation, 32 dB typ.
- compression, 3 dB higher than LO power
- protected by US Patent 6,807,407

Applications

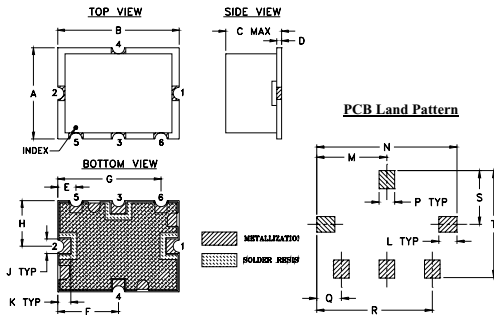
- aeronautical communication
- differential GPS
- fixed satellite
- mobile satellite
- geostationary mobile

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Electrical Specifications at 25°C

| Parameter | Min. | Typ. | Max. | Unit |
|------------------------------------|------|------|------|------|
| Frequency Range, RF | 1430 | | 1650 | MHz |
| Frequency Range, LO | 1520 | — | 1740 | MHz |
| Frequency Range, IF | 10 | — | 300 | MHz |
| Conversion Loss | — | 7.3 | 8.3 | dB |
| LO to RF Isolation | 35 | 45 | — | dB |
| LO to IF Isolation | 24 | 32 | — | dB |
| IP3 | — | 32 | — | dBm |
| RF Input Power at 1 dB Compression | — | +20 | — | dBm |

Outline Drawing

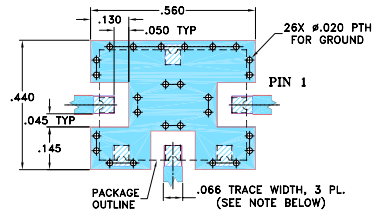


Suggested Layout, Tolerance to be within ±.002

Outline Dimensions (inch/mm)

| A | B | C | D | E | F | G | H | J | K |
|------|-------|-------|------|------|-------|-------|-------|------|------|
| .38 | .50 | .23 | .020 | .075 | .250 | .425 | .187 | .050 | .050 |
| 9.65 | 12.70 | 5.84 | 0.51 | 1.91 | 6.35 | 10.80 | 4.75 | 1.27 | 1.27 |
| L | M | N | P | Q | R | S | T | wt. | |
| .070 | .270 | .540 | .060 | .095 | .445 | .208 | .415 | | |
| 1.78 | 6.86 | 13.72 | 1.52 | 2.41 | 11.30 | 5.28 | 10.54 | | 0.8 |

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



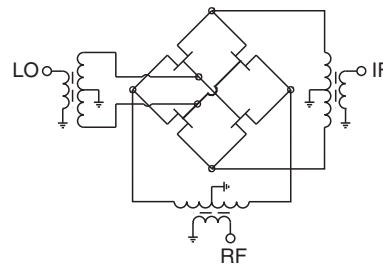
NOTE:

1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .039" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE. DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.

Typical Performance Data

| Frequency | | Conversion Loss (dB) | Isolation L-R (dB) | Isolation L-I (dB) | VSWR RF Port (:1) | VSWR LO Port (:1) | IP3 (dBm) |
|-----------|---------|----------------------|--------------------|--------------------|-------------------|-------------------|-----------|
| RF MHz | LO MHz | LO +17dBm | LO +17dBm | LO +17dBm | LO +17dBm | LO +17dBm | LO +17dBm |
| 1430.00 | 1520.00 | 7.14 | 47.79 | 31.97 | 1.42 | 1.85 | 30.22 |
| 1440.00 | 1530.00 | 7.08 | 47.17 | 31.70 | 1.39 | 1.79 | 31.18 |
| 1450.00 | 1540.00 | 7.07 | 47.12 | 31.60 | 1.39 | 1.73 | 31.59 |
| 1460.00 | 1550.00 | 7.02 | 47.17 | 31.69 | 1.38 | 1.67 | 32.20 |
| 1480.00 | 1570.00 | 6.97 | 47.75 | 31.92 | 1.39 | 1.55 | 32.20 |
| 1500.00 | 1590.00 | 7.01 | 46.48 | 31.92 | 1.38 | 1.43 | 31.94 |
| 1520.00 | 1610.00 | 7.13 | 45.39 | 32.04 | 1.37 | 1.34 | 33.16 |
| 1530.00 | 1620.00 | 7.22 | 45.50 | 32.03 | 1.38 | 1.30 | 33.71 |
| 1538.00 | 1628.00 | 7.27 | 45.31 | 32.15 | 1.39 | 1.28 | 34.08 |
| 1540.00 | 1630.00 | 7.28 | 45.26 | 32.21 | 1.39 | 1.28 | 34.15 |
| 1544.00 | 1634.00 | 7.28 | 45.08 | 32.35 | 1.40 | 1.27 | 33.68 |
| 1560.00 | 1650.00 | 7.21 | 44.51 | 32.98 | 1.40 | 1.26 | 32.73 |
| 1590.00 | 1680.00 | 7.24 | 44.81 | 33.72 | 1.39 | 1.31 | 32.03 |
| 1605.00 | 1695.00 | 7.26 | 44.64 | 34.20 | 1.38 | 1.36 | 32.23 |
| 1635.00 | 1725.00 | 7.33 | 45.43 | 35.26 | 1.41 | 1.46 | 31.11 |
| 1650.00 | 1740.00 | 7.32 | 45.23 | 35.92 | 1.39 | 1.52 | 30.80 |

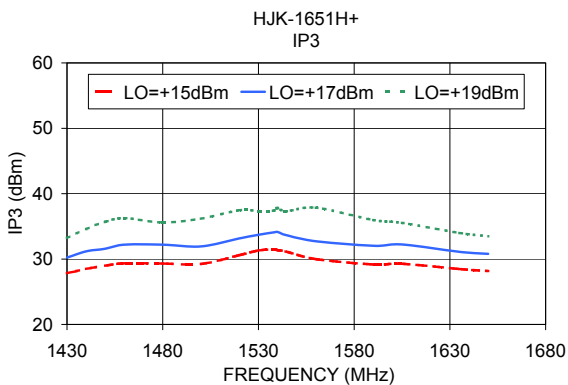
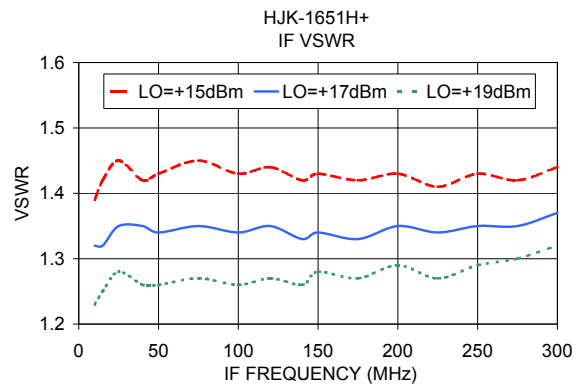
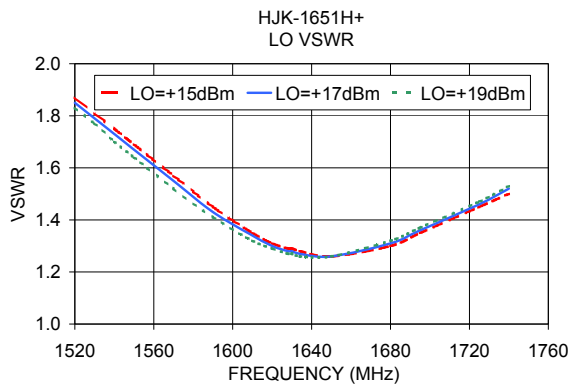
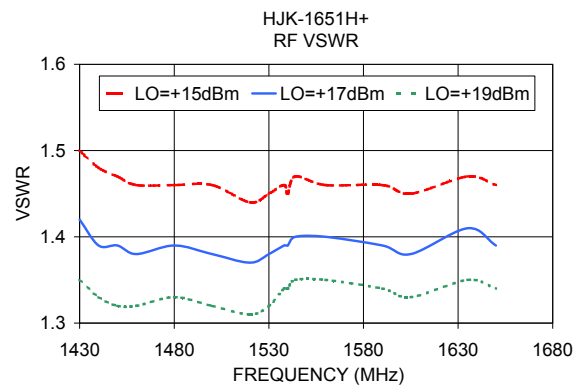
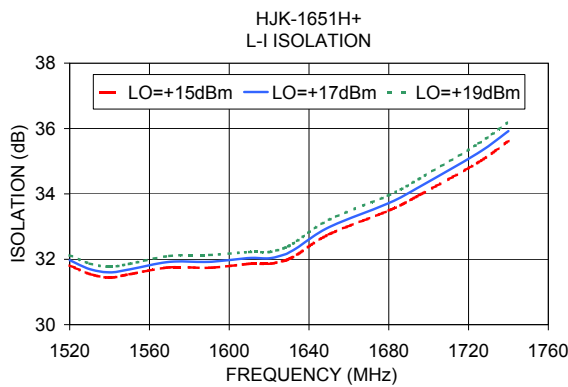
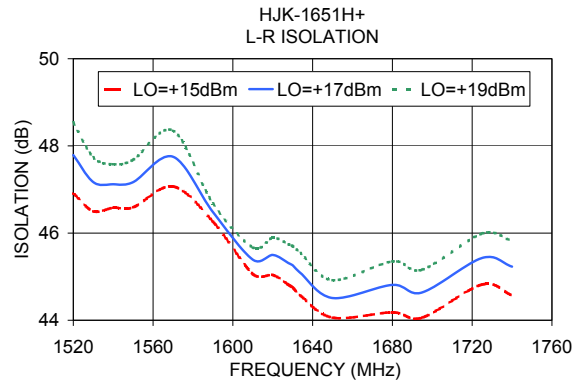
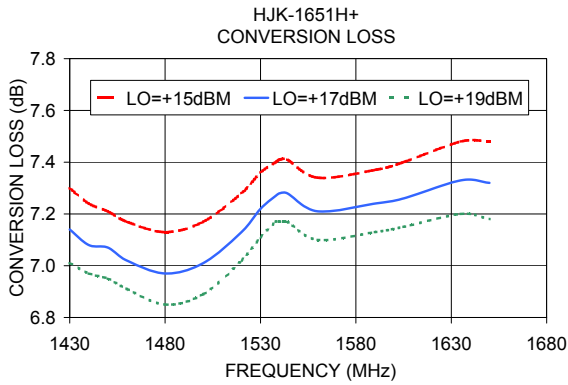
Electrical Schematic



Notes

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